

N- Channel 100-V (D-S) MOSFET

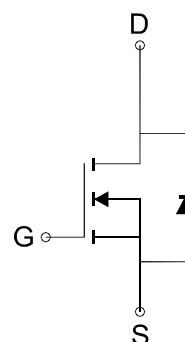
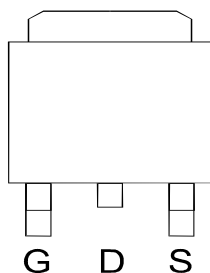
GENERAL DESCRIPTION

The ME50N10 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION

(TO-252-3L)

Top View



N-Channel MOSFET

Ordering Information: ME50N10 (Pb-free)

ME50N10-G (Green product-Halogen free)

Absolute Maximum Ratings (Tc=25°C Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _c =25°C	I _D	50.5	A
	T _c =70°C		40.4	
Single pulse Avalanche Energy L=0.5mH	T _c =25°C	I _{AS}	23.1	A
Single pulse Avalanche Energy L=0.5mH	T _c =25°C	E _{AS}	133	mJ
Pulsed Drain Current		I _{DM}	202	A
Maximum Power Dissipation	T _c =25°C	P _D	69.4	W
	T _c =70°C		44.4	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C
Thermal Resistance-Junction to Case*		R _{θJC}	1.8	°C/W

* The device mounted on 1in² FR4 board with 2 oz copper.

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Electrical Characteristics (Tc=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μ A	100			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250 μ A	2.0		4.0	V
I _{GSS}	Gate-Body Leakage	V _{DS} =0V, V _{GS} = $\pm$ 20V			$\pm$ 100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V			1	μ A
R _{DS(ON)}	Drain-Source On-Resistance*	V _{GS} =10V, I _D =25A		14	17	m Ω
V _{SD}	Diode Forward Voltage *	I _S =45A, V _{GS} =0V		0.9	1.2	V
DYNAMIC						
Q _g	Total Gate Charge	V _{DD} =80V, V _{GS} =10V, I _D =28A		121		nC
Q _g	Total Gate Charge	V _{DD} =80V, V _{GS} =4.5V, I _D =28A		28		
Q _{gs}	Gate-Source Charge			28.6		
Q _{gd}	Gate-Drain Charge			34.4		
R _g	Gate Resistance	V _{DS} =0V, V _{GS} =0V, f=1MHz		0.8		Ω
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz		6170		pF
C _{oss}	Output Capacitance			427		
C _{rss}	Reverse Transfer Capacitance			307		
t _{d(on)}	Turn-On Delay Time	V _{GS} =10V, R _L =1.8 Ω V _{DD} =50V, R _G =2.5 Ω , I _D =28A		42.4		ns
t _r	Turn-On Rise Time			85.7		
t _{d(off)}	Turn-Off Delay Time			154		
t _f	Turn-Off Fall Time			25		

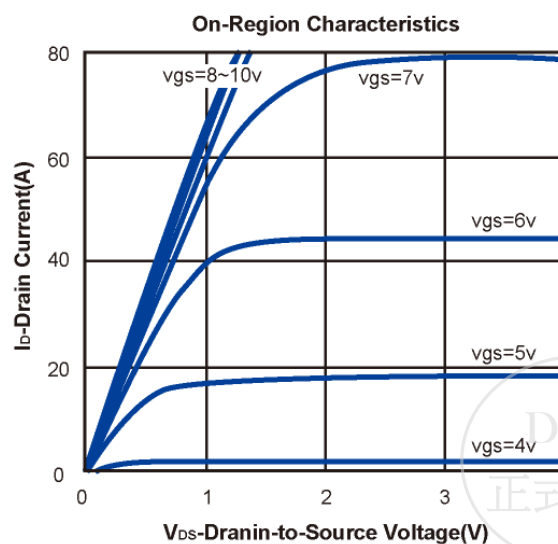
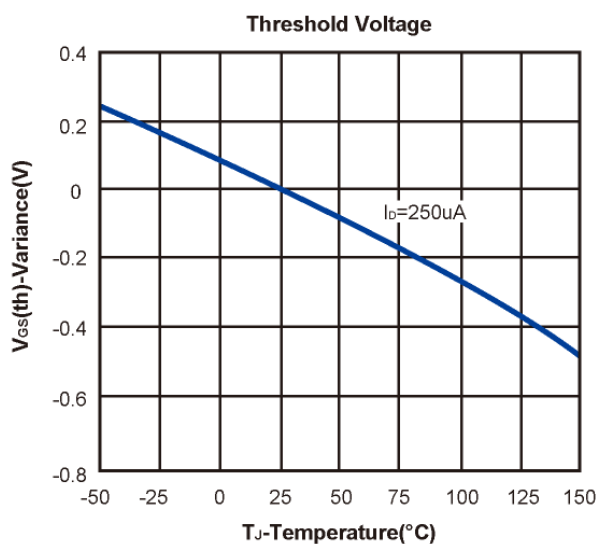
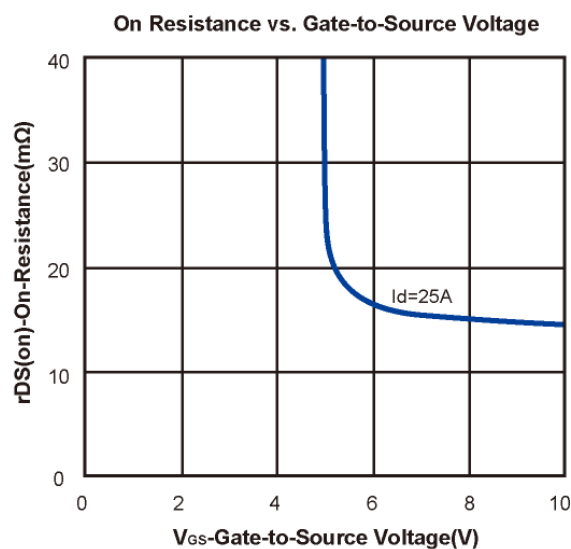
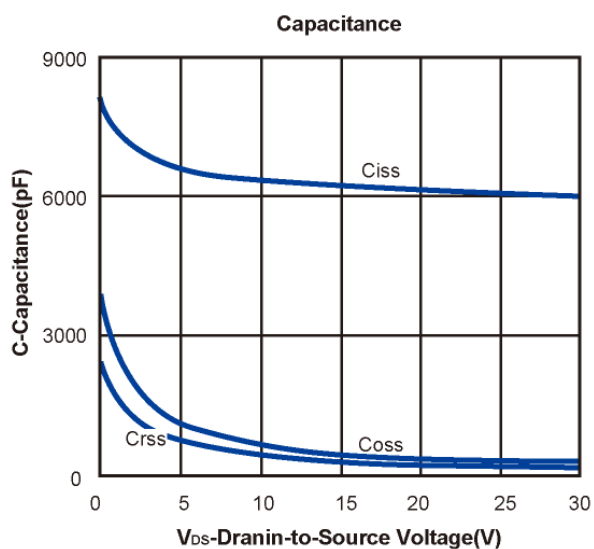
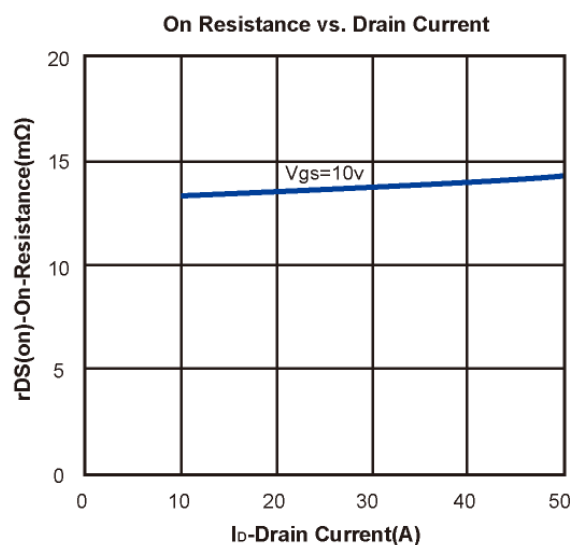
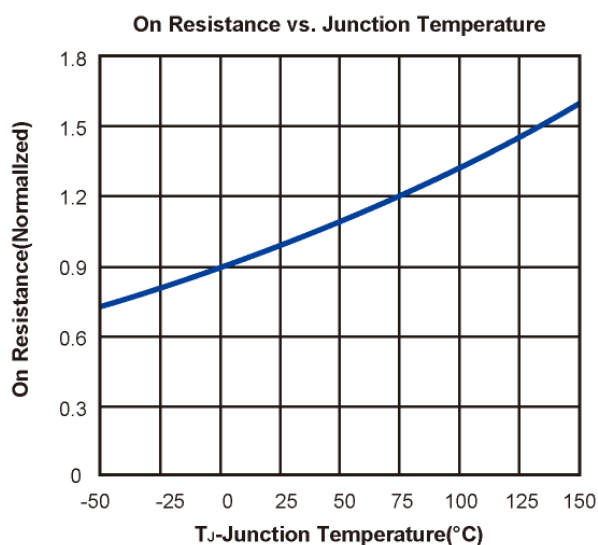
Notes: a. pulse test: pulse width $\leq$ 300 μ s, duty cycle $\leq$ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



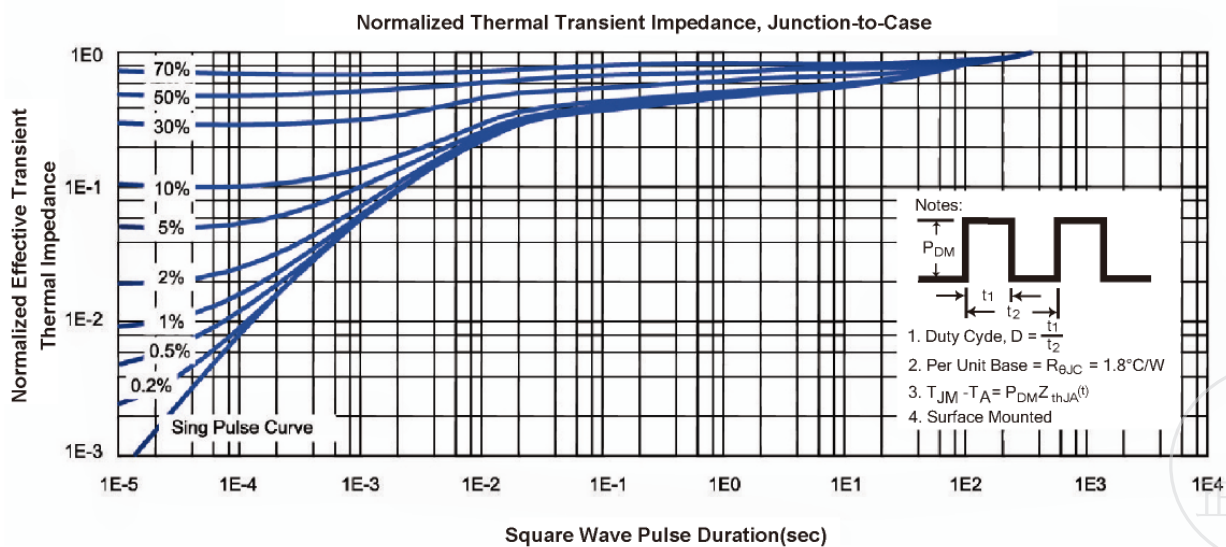
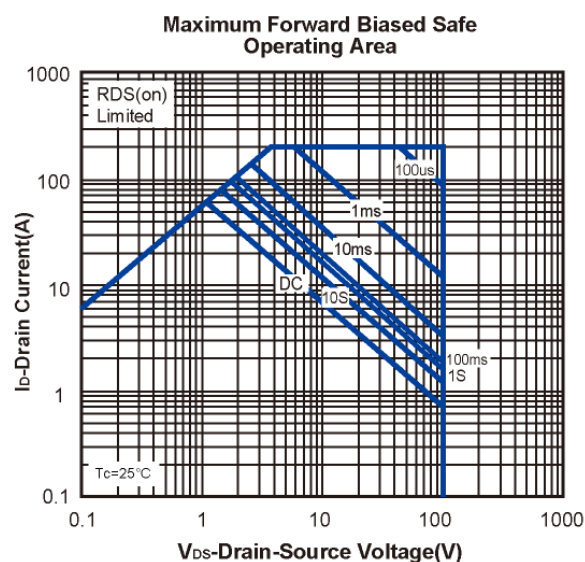
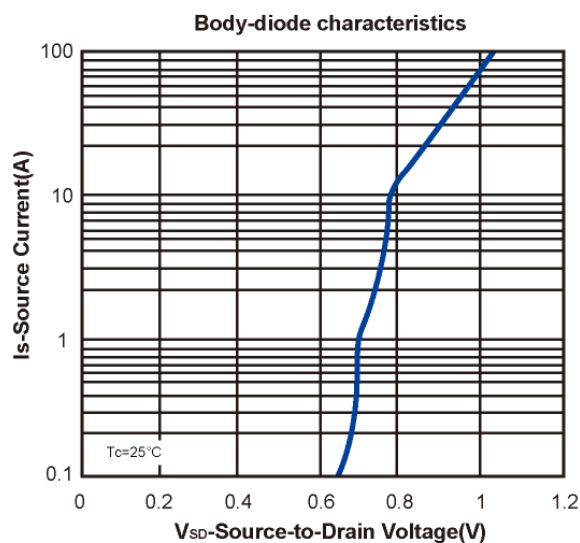
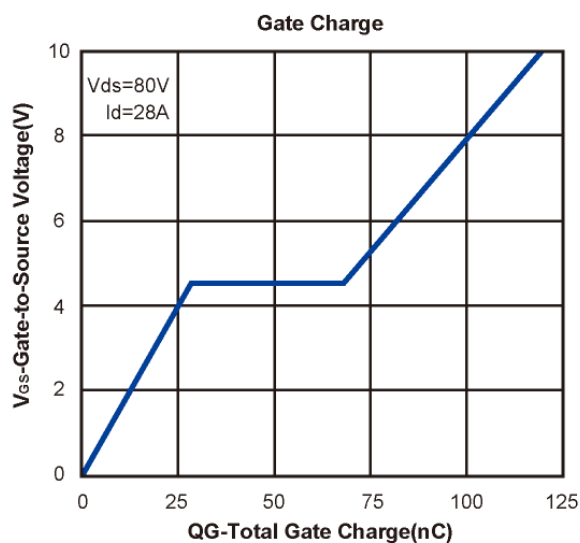
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Typical Characteristics (T_J =25°C Noted)

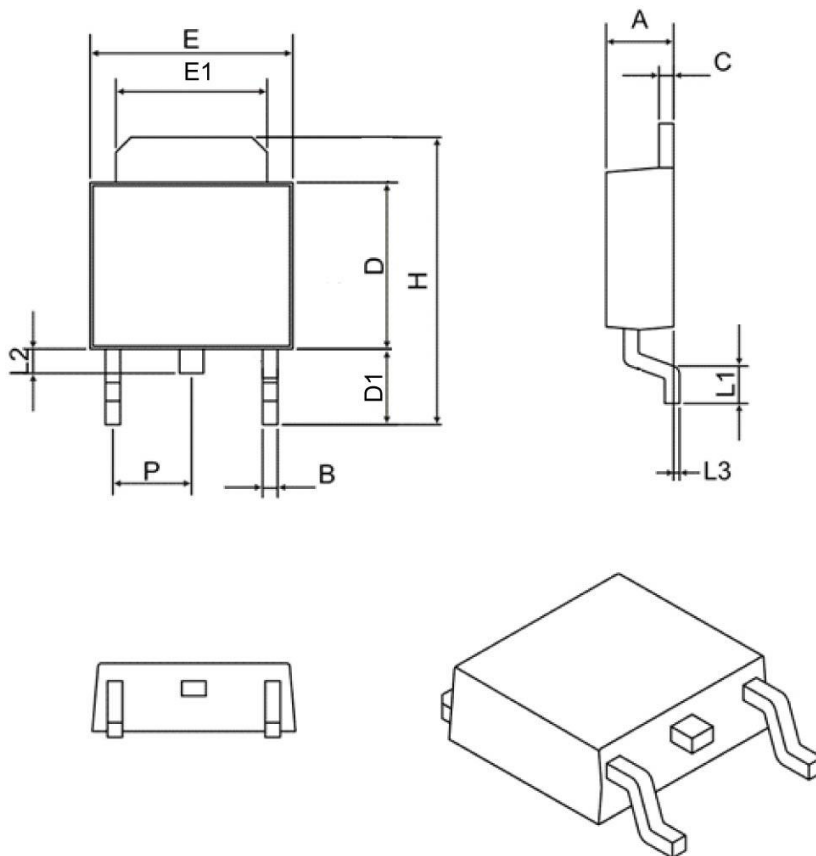


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TO-252 Package Outline



SYMBOL	MIN	MAX
A	2.10	2.50
B	0.40	0.90
C	0.40	0.90
D	5.30	6.30
D1	2.20	2.90
E	6.30	6.75
E1	4.80	5.50
L1	0.90	1.80
L2	0.50	1.10
L3	0.00	0.20
H	8.90	10.40
P	2.30 BSC	

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